IEEE P802.11
Wireless LANs

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| MAC Minutes for TGbe Ad-Hoc teleconferences in May and July 2022 |
| Date: 2022-07-07 |
| Author(s): |
| Name | Affiliation | Address | Phone | email |
| Liwen Chu | NXP |  |  |  |
| Jeongki Kim | Ofinno |  |  |  |
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Abstract

This document contains the meeting minutes for the TGbe MAC ad hoc teleconferences held in May 2022 and July 2022.

Revisions:

* Rev0: Added the minutes from the telephone conferences held on July 07,

**Thursday 07 July 2021, 10:00am – 12:00pm ET (TGbe MAC ad hoc conference call)**

Chairman: Jeongki Kim (Ofinno)

Secretary: Liwen Chu (NXP)

This meeting took place using a webex session.

**Introduction**

1. The Chair (Jeongki, Ofinno) calls the meeting to order at 10:04am EDT. The Chair introduces himself and the Secretary, Liwen (NXP)
2. The Chair goes through the 802 and 802.11 IPR policy and procedures and asks if there is anyone that is aware of any potentially essential patents.
	1. Nobody responds.
3. The Chair goes through the IEEE copyright policy.
4. The Chair recommends using IMAT for recording the attendance.
	* Please record your attendance during the conference call by using the IMAT system:
		1. 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
	* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Liwen Chu (liwen.chu@nxp.com) and Jeongki Kim (jeongki.kim.ieee@gmail.com)
5. The agenda in 11-22/974r1 is approved.

**Recorded attendance through Imat and e-mail:**

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 **Submissions**

1. 11-22/972r2 Edward Au

The TG editor goes through 11-22/971r2 to allocate CIDs to POCs. At the end of the meeting, some CIDs are not coverred. The TG editor asks what can be done for those CIDs. The TG chair mentions that the memebers can send email about them.

There is no response to chair’s request for other business. The meeting is adjorned at 12:00pm.